

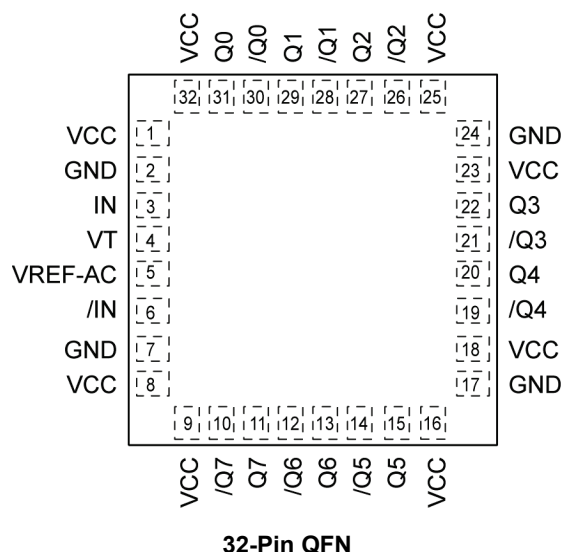
Ordering Information

Part Number ⁽¹⁾	Package Type	Operating Range	Package Marking	Lead Finish
SY58031UMG	QFN-32	Industrial	SY58031U with Pb-free bar-line indicator	Pb-Free NiPdAu
SY58031UMGTR ⁽²⁾	QFN-32	Industrial	SY58031U with Pb-free bar-line indicator	Pb-Free NiPdAu

Note:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^{\circ}\text{C}$, DC electricals only.
2. Tape and Reel.

Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Function
3, 6	IN, /IN	Differential signal input: Each pin of this pair internally terminates with 50Ω to the VT pin. Note that this input will default to an indeterminate state if left open. See Input Interface Applications section.
4	VT	Input termination center-tap: Each input terminates to this pin. The VT pin provides a center-tap for each input (IN, /IN) to the termination network for maximum interface flexibility. See Input Interface Applications section.
2, 7, 17, 24	GND, Exposed Pad	Ground. Exposed pad must be connected to a ground plane that is the same potential as the ground pin.
1, 8, 9, 16 18, 23, 25, 32	VCC	Positive power supply: Bypass with 0.1μF/0.01μF low ESR capacitors as close to the pins as possible
31, 30, 29, 28, 27, 26, 22, 21 20, 19, 15, 14 13, 12, 11, 10	Q0, /Q0, Q1, /Q1 Q2, /Q2, Q3, /Q3 Q4, /Q4, Q5, /Q5 Q6, /Q6, Q7, /Q7	CML differential output pairs: Differential buffered output copy of the input signal. The CML output swing is typically 400mV into 50Ω. Unused output pairs may be left floating with no impact on jitter. See CML Output Termination section
5	VREF-AC	Bias Reference Voltage: Equal to $V_{CC}-1.2V$ (typical), and used for AC-coupled applications. See Input Interface Applications section. When using V_{REF-AC} , bypass with 0.01μF capacitor to V_{CC} . Maximum sink/source current is 0.5mA.

Absolute Maximum Ratings⁽³⁾

Power Supply Voltage (VCC).....	–0.5V to +4.0V
Input Voltage (VIN).....	–0.5V to VCC
Current (VT)	
Source or sink current on VT pin.....	±100mA
Input Current (VT)	
Source or sink current on IN, /IN.....	±50mA
Current (VREF)	
Source or sink current on VREF-AC ⁽⁵⁾	±1.5mA
Lead Temperature (soldering, 20s).....	260°C
Storage Temperature (Ts).....	–65°C to +150°C

Operating Ratings⁽⁴⁾

Power Supply Voltage (VCC)	+2.375V to +3.6V
Ambient Temperature (TA)	–40°C to +85°C
Junction Thermal Resistance ⁽⁶⁾	
QFN (θ_{JA}), Still-Air.....	35°C/W
QFN (ψ_{JB}), Junction-to-Board	20°C/W

DC Electrical Characteristics⁽⁷⁾

T_A = –40°C to +85°C.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V _{CC}	Power supply voltage	2.5V nominal 3.3V nominal	2.375 3.0	2.5 3.3	2.625 3.6	V
I _{CC}	Power supply current	VCC = max., no load. Includes current through 50Ω pull-ups.		265	330	mA
V _{IH}	Input HIGH voltage	IN1, /IN1, Note 8	V _{CC} -1.6		V _{CC}	V
V _{IL}	Input LOW voltage	IN1, /IN1	0		V _{IH} -0.1	V
V _{IN}	Input voltage swing	IN1, /IN1, see Figure 1 .	0.1		1.7	V
V _{DIFF_IN}	Differential input voltage swing [IN0, /IN0], [IN1, /IN1]	IN1, /IN1, see Figure 2 .	0.2			V
R _{IN}	In-to-V _T resistance		40	50	60	Ω
V _{T IN}	Max. In-to-V _T (IN, /IN)				1.28	V
V _{REF-AC}			V _{CC} -1.3	V _{CC} -1.2	V _{CC} -1.1	V

CML DC Electrical Characteristics⁽⁷⁾

$V_{CC} = 2.5V \pm 5\%$ or $3.3V \pm 10\%$; $R_L = 100\Omega$ across Q and /Q; $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise stated.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{OH}	Output HIGH voltage		$V_{CC} - 0.02$		V_{CC}	V
V_{OUT}	Output LOW voltage	See Figure 1.	325	400		mV
V_{DIFF_OUT}	Differential voltage swing	See Figure 2.	650	800		mV
R_{OUT}	Output source impedance		40	50	60	Ω

Notes:

- Exceeding the absolute maximum ratings may damage the device.
- The datasheet ratings are not guaranteed if the device is operated beyond the operating ratings.
- Due to the limited drive capability, use for input of the same package only.
- Thermal performance assumes exposed pad is soldered (or equivalent) to the device's most negative potential (GND) on the PCB. ψ_{JB} uses 4-layer θ_{JA} in still-air number unless otherwise stated.
- The device is not guaranteed to function outside its operating ratings.
- V_{IH} (min.) not lower than 1.2V.

AC Electrical Characteristics⁽⁹⁾

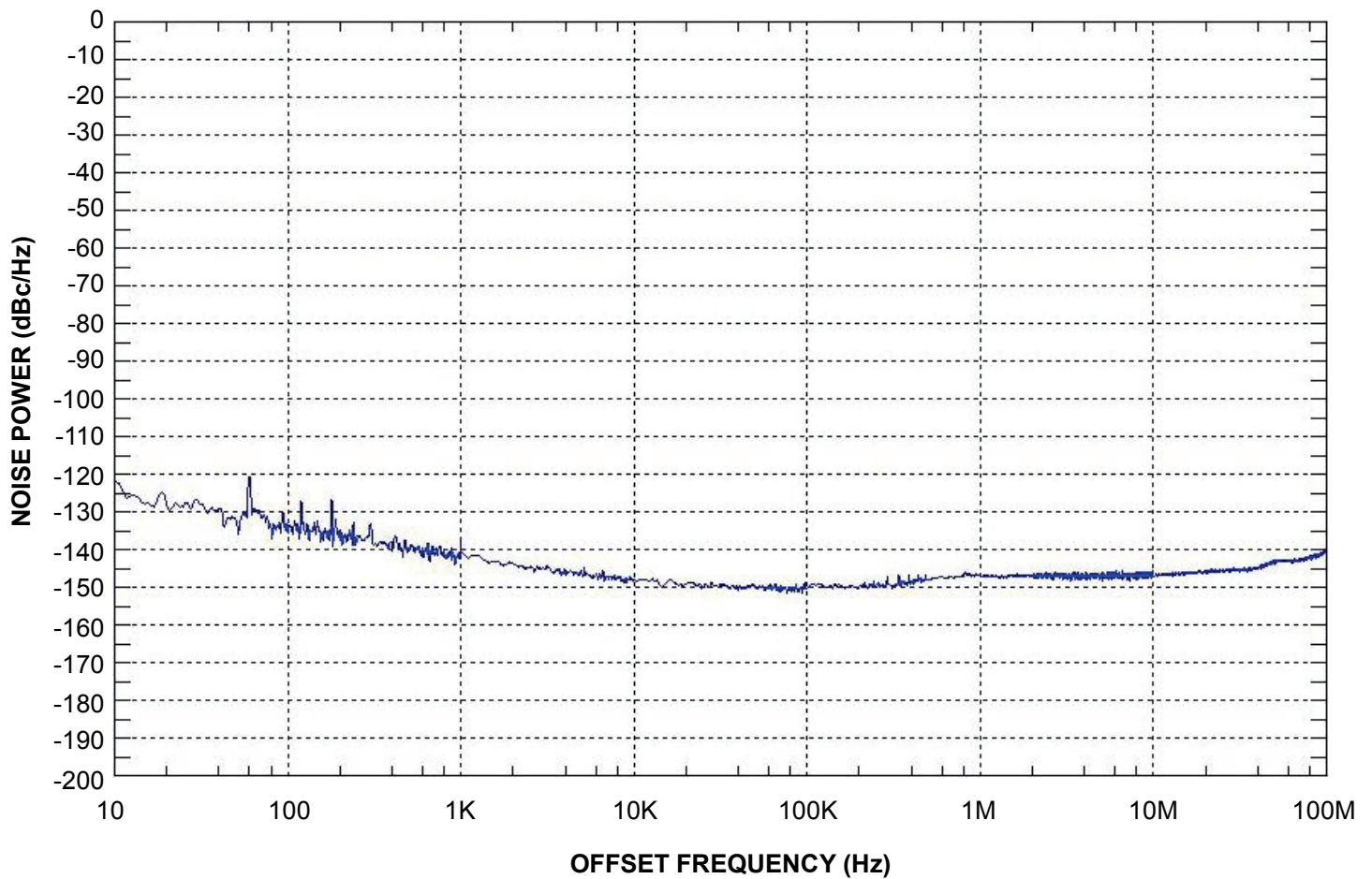
$V_{CC} = 2.5V \pm 5\%$ or $3.3V \pm 10\%$; $R_L = 100\Omega$ across each output pair or equivalent; $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise stated.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
f_{MAX}	Maximum operating frequency	$V_{OUT} \geq 200mV$ clock	6			GHz
t_{pd}	Propagation delay (IN-to-Q)		120	230	270	ps
$t_{pd\ tempco}$	Differential propagation delay temperature coefficient			35		fs/ $^\circ C$
t_{SKEW}	Output-to-output (within device)	Note 10		7	20	ps
	Part-to-part	Note 11			100	ps
t_{JITTER}	RMS phase jitter	Output: 622MHz Integration range 12kHz – 20MHz		75		ps
t_r/t_f	Output rise/fall time	20% to 80% at full output swing.	20	45	60	ps

Notes:

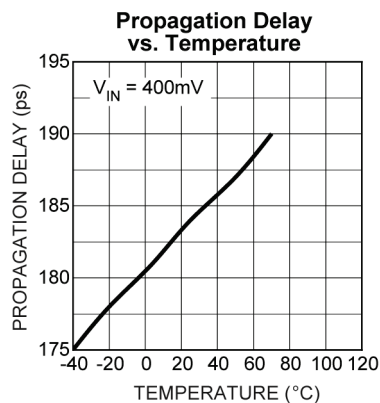
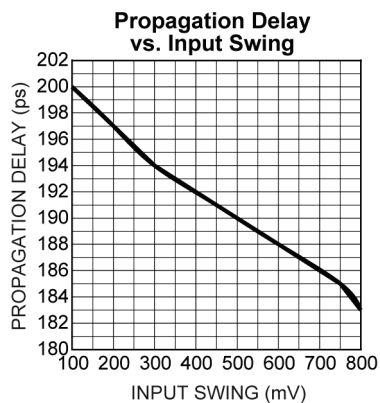
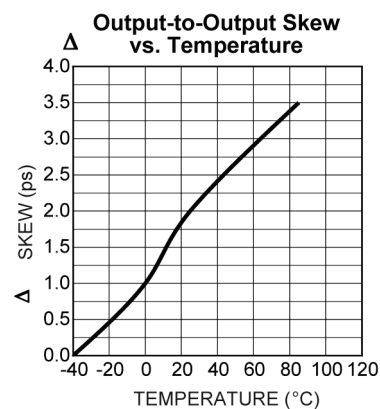
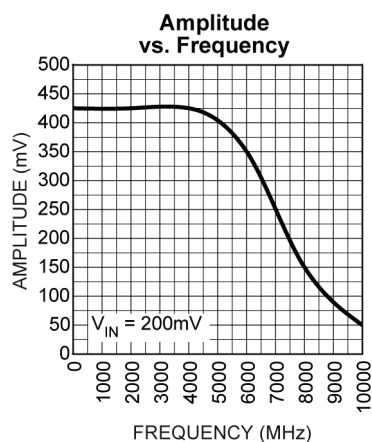
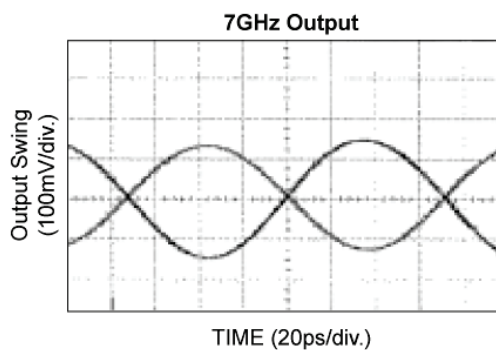
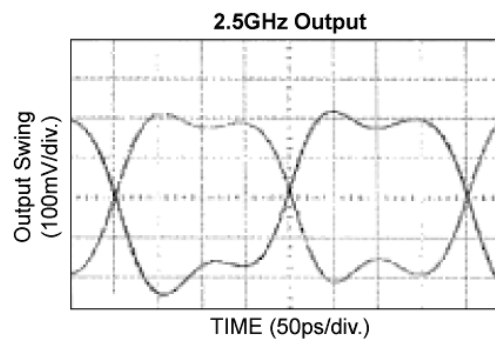
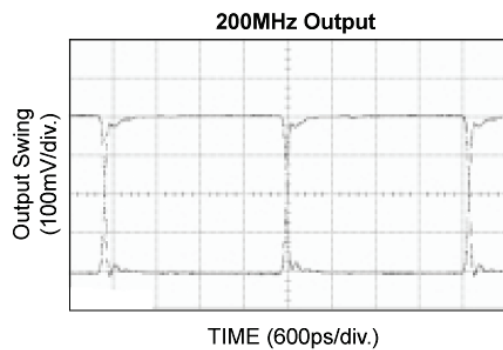
- High frequency AC electricals are guaranteed by design and characterization. All outputs loaded, $V_{IN} \geq 100mV$.
- Output-to-output skew is measured between outputs under identical transitions.
- Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature with no skew of the edges at the respective inputs. Part-to-part skew includes variation in t_{pd} .

Phase Noise Plot



Phase Noise Plot: 622MHz @ 3.3V

Typical Operating Characteristics



Single-Ended and Differential Swings

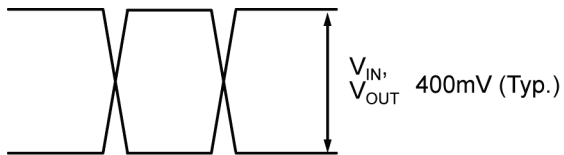


Figure 1. Single-Ended Voltage Swing

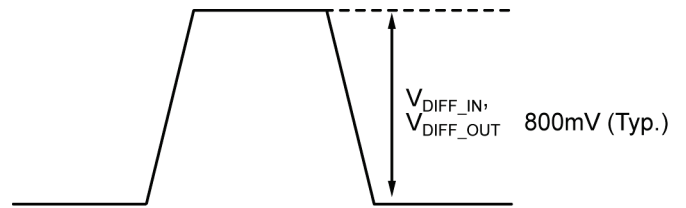
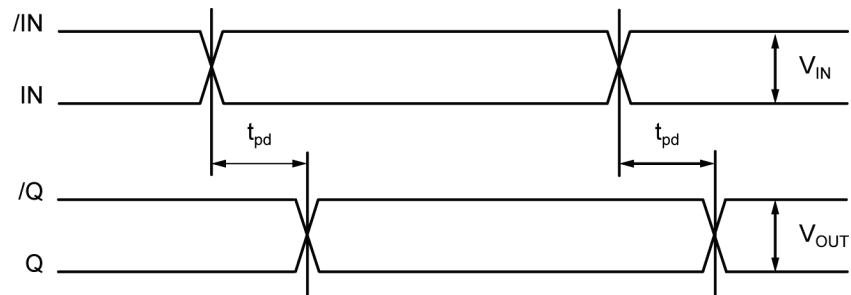


Figure 2. Differential Voltage Swing

Timing Diagram



Input Buffer

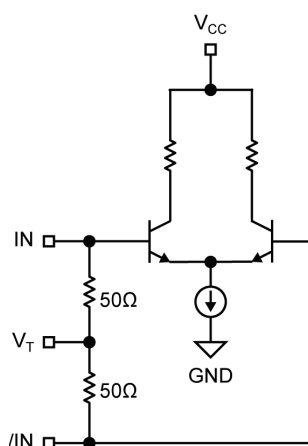


Figure 3. Simplified Differential Input Buffer

Input Interface Applications

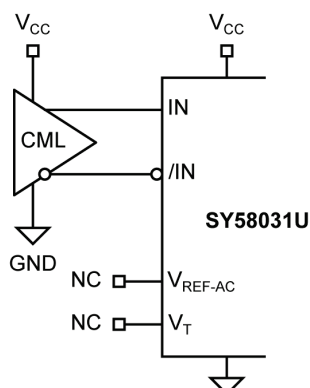


Figure 4. DC-Coupled CML Input Interface
Optional: May connect V_T to V_{CC}

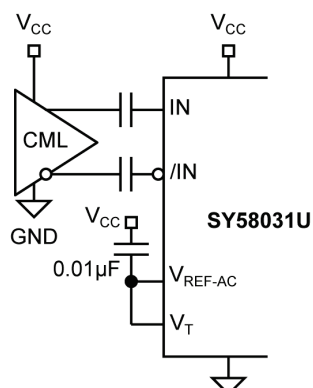


Figure 5. AC-Coupled CML Input Interface

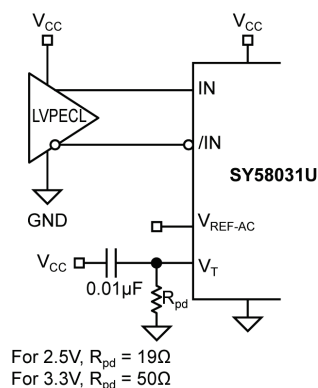


Figure 6. LVPECL Input Interface

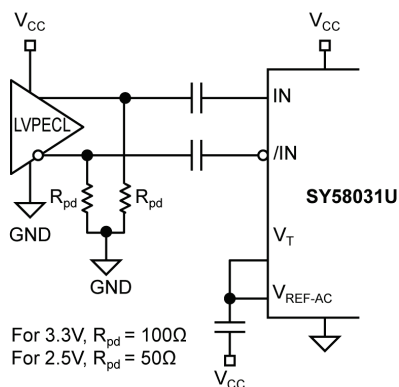


Figure 7. AC-Coupled LVPECL Input Interface

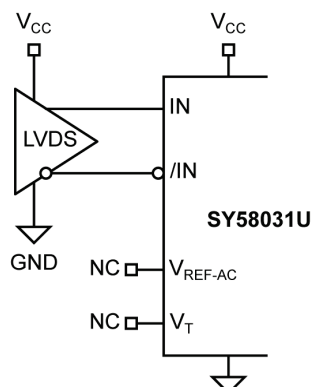


Figure 8. LVDS Input Interface

CML Output Termination

Figure 9 and Figure 10 illustrate how to terminate a CML output using both the AC- and DC-coupled configuration. All outputs of the SY58031U are 50Ω with a 16mA current source.

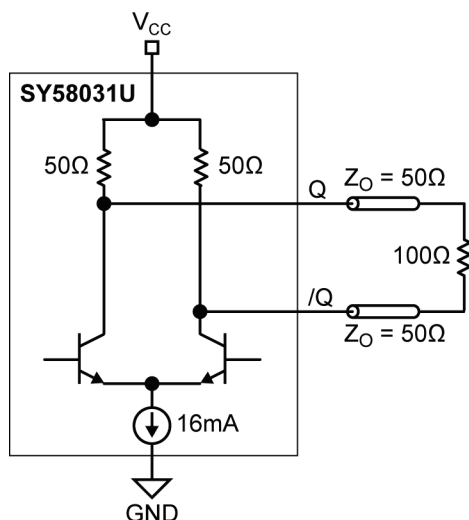


Figure 9. CML DC-Coupled Termination

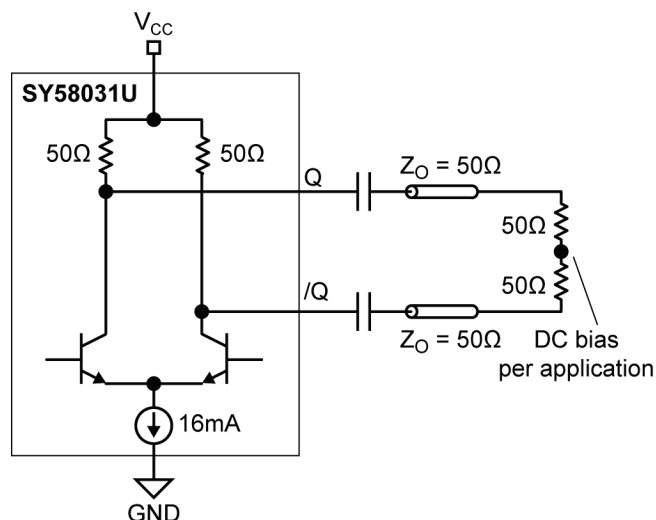
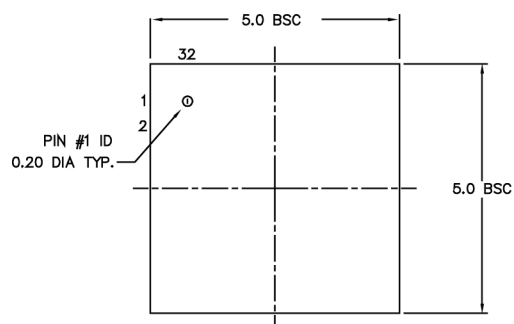


Figure 10. CML AC-Coupled Termination

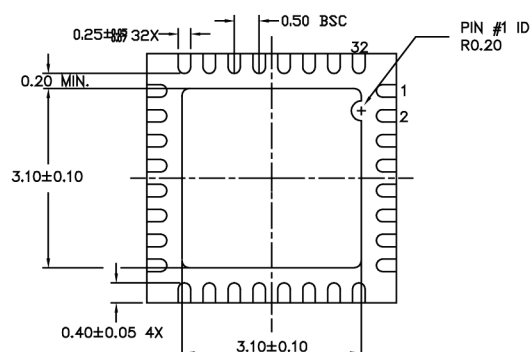
Related Micrel Products and Support Documentation

Part Number	Function	Website Link
SY58031U	Ultra-Precision 1:8 CML Fanout Buffer with Internal I/O Termination	http://www.micrel.com/PDF/HBW/sy58031u.pdf
SY58032U	Ultra-Precision 1:8 LVPECL Fanout Buffer with Internal Termination	http://www.micrel.com/PDF/HBW/sy58032u.pdf
SY58033U	Ultra-Precision 1:8 400mV Fanout Buffer with Internal Termination	http://www.micrel.com/PDF/HBW/sy58033u.pdf
	HBW Solutions	http://www.micrel.com/index.php/en/products/clock-timing.html

Package Information^(12, 13)



TOP VIEW



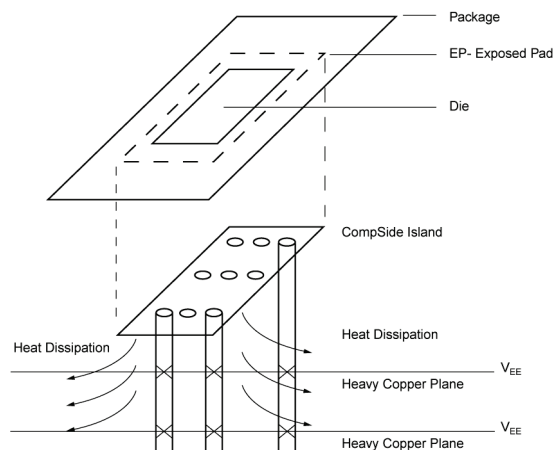
BOTTOM VIEW



SIDE VIEW

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MAX. PACKAGE WARPAGE IS 0.05 mm.
3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.



32-Pin QFN and PCB Thermal Consideration for Package (Always solder, or equivalent, the exposed pad to the PCB)

Note:

12. Package information is correct as of the publication date. For updates and most current information, go to www.micrel.com.
13. Package meets Level 2 qualification. All parts are dry-packaged before shipment. Exposed pads must be soldered to a ground for proper thermal management.

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USATEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

Micrel makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Micrel does not assume responsibility for its use. Micrel reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Micrel's terms and conditions of sale for such products, Micrel assumes no liability whatsoever, and Micrel disclaims any express or implied warranty relating to the sale and/or use of Micrel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is a Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2013 Micrel, Incorporated.